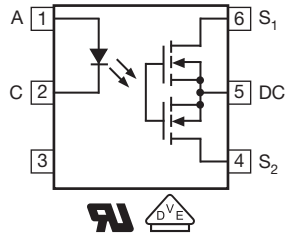
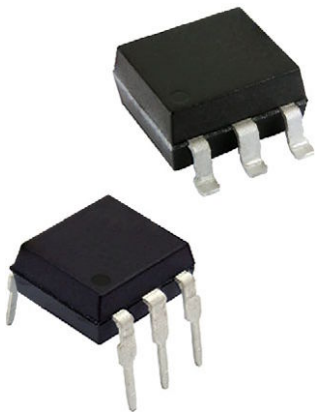


## 1 Form A Solid-State Relay (Normally Open)



### FEATURES

- Current limit protection
- Isolation test voltage 5300 V<sub>RMS</sub>
- Typical R<sub>ON</sub> 22 Ω
- Load voltage 350 V
- Load current 120 mA / 250 mA
- Clean bounce free switching
- Low power consumption
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### APPLICATIONS

- General telecom switching
- Security equipment
- Instrumentation
- Industrial controls

### DESCRIPTION

The LH1540 is robust, ideal for telecom and ground fault applications. It is an SPST normally open switch (1 Form A) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and MOSFETs for the switch output. In addition, it employs current-limiting circuitry to provide overvoltage protection.

### AGENCY APPROVALS

- UL1577, file no. E52744
- DIN EN 60747-5-5 (VDE0884-5), available with option 1

ORDERING INFORMATION													
L	H	1	5	4	0	#	#	#	T	R	 DIP-6	 SMD-6	
PART NUMBER						ELECTR. VARIATION	PACKAGE CONFIG.			TAPE AND REEL		7.62 mm	> 0.1 mm
PACKAGE						UL			UL, VDE (OPTION 1)				
SMD-6, tube						LH1540AAB			LH1540AAB-X001				
SMD-6, tape and reel						LH1540AABTR			-				
DIP-6, tube						LH1540AT			LH1540AT-X001				



ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
IRED continuous forward current		I <sub>F</sub>	50	mA
IRED reverse voltage		V <sub>R</sub>	5	V
Input power dissipation		P <sub>diss</sub>	80	mW
<b>OUTPUT</b>				
DC or peak AC load voltage		V <sub>L</sub>	350	V
Continuous load current (AC/DC configuration)		I <sub>L</sub>	120	mA
Continuous load current (DC only configuration)		I <sub>L</sub>	250	mA
SSR output power dissipation (continuous)		P <sub>diss</sub>	550	mW
<b>SSR</b>				
Ambient temperature range		T <sub>amb</sub>	-40 to +85	°C
Storage temperature range		T <sub>stg</sub>	-40 to +150	°C
Soldering temperature	t = 10 s max.	T <sub>slid</sub>	260	°C

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability

ELECTRICAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>						
IRED forward current, switch turn-on	I <sub>L</sub> = 100 mA, t = 10 ms	I <sub>Fon</sub>	-	0.3	2	mA
IRED forward current, switch turn-off	V <sub>L</sub> = 350 V	I <sub>Foff</sub>	0.05	0.15	-	mA
IRED forward voltage	I <sub>F</sub> = 10 mA	V <sub>F</sub>	-	1.36	1.45	V
<b>OUTPUT</b>						
On-resistance (AC/DC configuration)	I <sub>F</sub> = 5 mA, I <sub>L</sub> = 50 mA	R <sub>ON</sub>	-	22	27	Ω
On-resistance (DC only configuration)	I <sub>F</sub> = 5 mA, I <sub>L</sub> = 100 mA	R <sub>ON</sub>	-	5.2	7	Ω
Off-resistance	I <sub>F</sub> = 0 mA, V <sub>L</sub> = ± 100 V	R <sub>OFF</sub>	0.5	5000	-	GΩ
Off-state leakage current	I <sub>F</sub> = 0 mA, V <sub>L</sub> = ± 100 V	I <sub>O</sub>	-	< 1	200	nA
	I <sub>F</sub> = 0 mA, V <sub>L</sub> = ± 350 V	I <sub>O</sub>	-	6	1000	nA
Output capacitance (AC/DC configuration)	I <sub>F</sub> = 0 mA, V <sub>L</sub> = 1 V, 1 MHz	C <sub>O</sub>	-	39	-	pF
	I <sub>F</sub> = 0 mA, V <sub>L</sub> = 50 V, 1 MHz	C <sub>O</sub>	-	6	-	pF
Current limit (AC/DC configuration)	I <sub>F</sub> = 5 mA, t = 5 ms, V <sub>L</sub> = ± 6 V	I <sub>limit</sub>	170	300	450	mA
<b>TRANSFER</b>						
Capacitance (input to output)	V <sub>ISO</sub> = 1 V	C <sub>IO</sub>	-	0.4	-	pF

**Note**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements

**PIN CONFIGURATION**

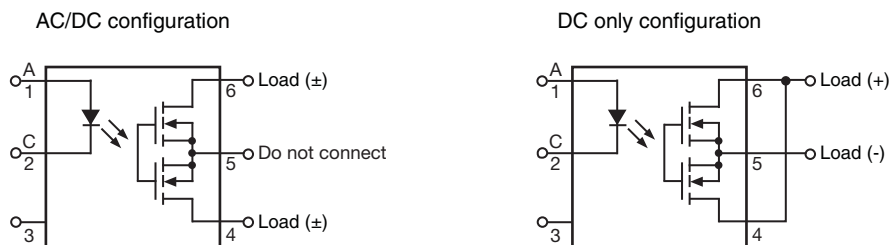


Fig. 1 - Pin Configuration

<b>SWITCHING CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$t_{on}$	-	0.13	2	ms
Turn-off time	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$t_{off}$	-	0.05	2	ms

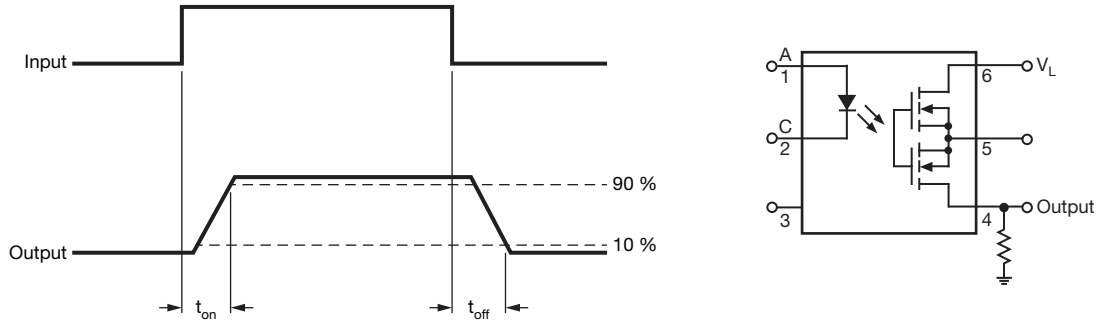


Fig. 2 - Timing Schematic

<b>SAFETY AND INSULATION RATINGS</b>				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 85 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	$V_{ISO}$	5300	$V_{RMS}$
Maximum transient isolation voltage	According to DIN EN 60747-5-5	$V_{IOTM}$	8000	$V_{peak}$
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	$V_{IORM}$	890	$V_{peak}$
Isolation resistance	$V_{IO} = 500\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{12}$	$\Omega$
	$V_{IO} = 500\text{ V}$ , $T_{amb} = 100\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{11}$	$\Omega$
Output safety power		$P_{SO}$	700	mW
Input safety current		$I_{SI}$	240	mA
Safety temperature		$T_S$	175	$^{\circ}\text{C}$
Creepage distance			$\geq 7$	mm
Clearance distance			$\geq 7$	mm
Insulation thickness		DTI	$\geq 0.4$	mm
Input to output test voltage, method B	$V_{IORM} \times 1.875 = V_{PR}$ , 100 % production test with $t_M = 1\text{ s}$ , partial discharge $< 5\text{ pC}$	$V_{PR}$	1669	$V_{peak}$
Input to output test voltage, method A	$V_{IORM} \times 1.6 = V_{PR}$ , 100 % sample test with $t_M = 10\text{ s}$ , partial discharge $< 5\text{ pC}$	$V_{PR}$	1424	$V_{peak}$

**Note**

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

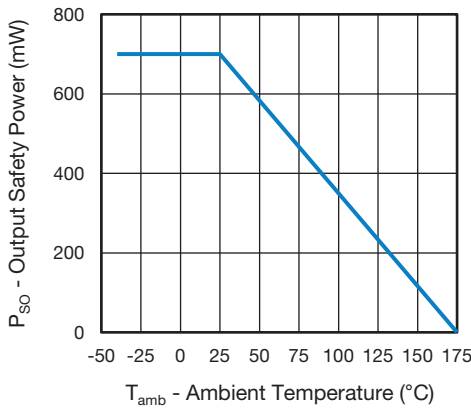


Fig. 3 - Safety Power Dissipation vs. Ambient Temperature

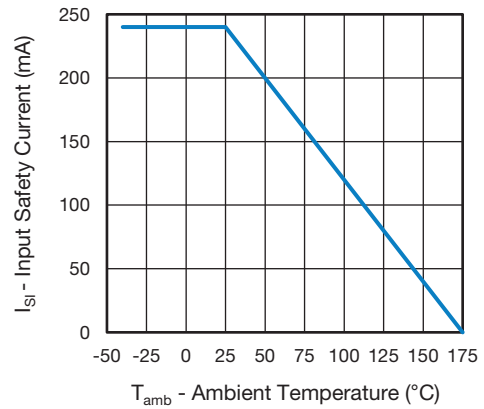


Fig. 4 - Safety Input Current vs. Ambient Temperature

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

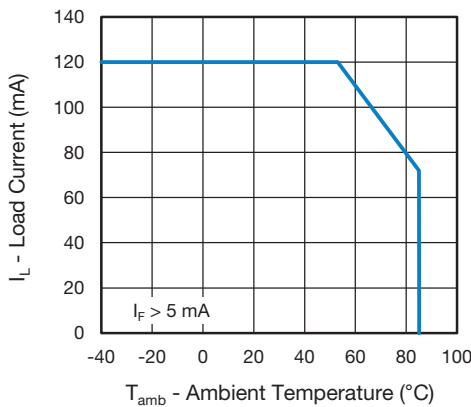


Fig. 5 - Maximum Load Current vs. Ambient Temperature

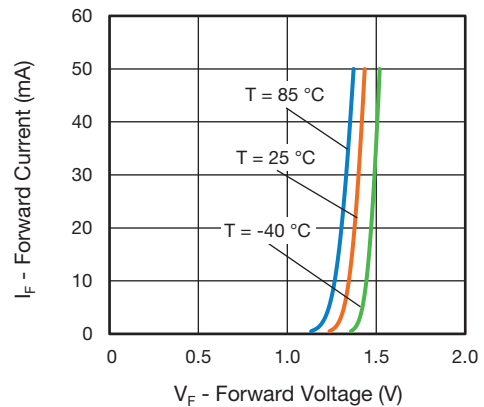


Fig. 7 - Forward Current vs. Forward Voltage

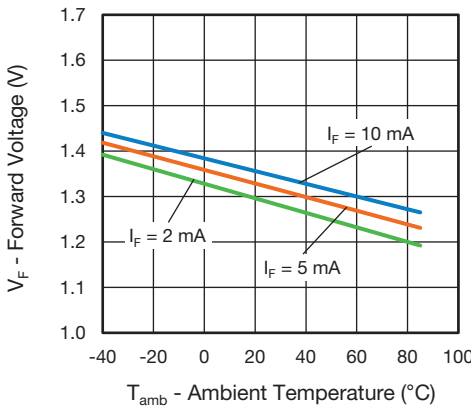


Fig. 6 - Forward Voltage vs. Ambient Temperature

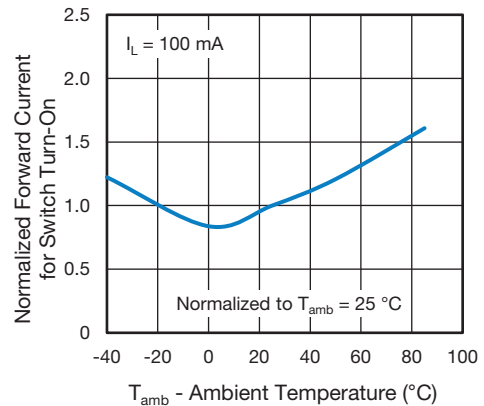


Fig. 8 - Normalized Forward Current for Switch Turn-On vs. Ambient Temperature

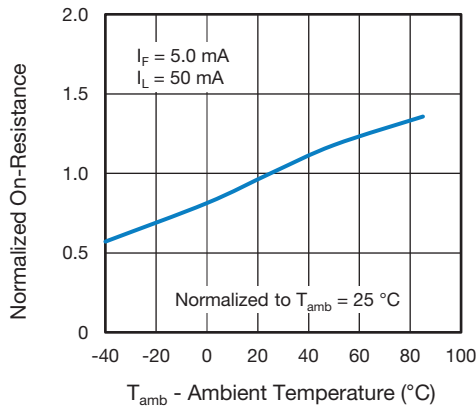


Fig. 9 - Normalized On-Resistance vs. Ambient Temperature

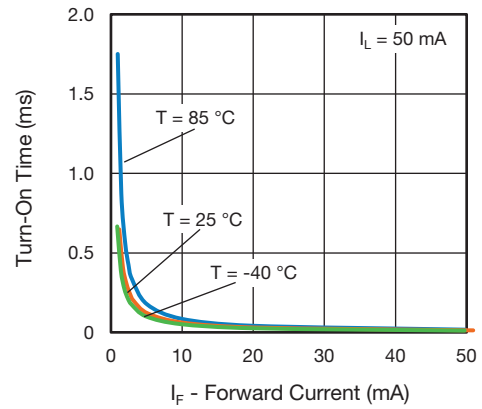


Fig. 12 - Turn-On Time vs. Forward Current

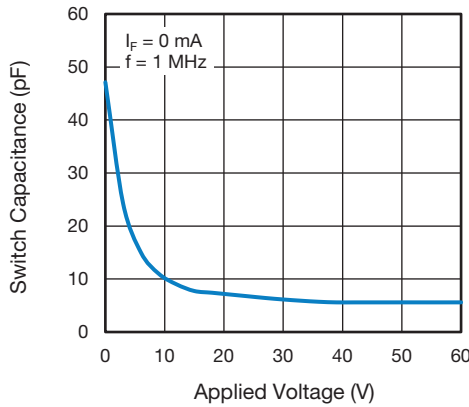


Fig. 10 - Switch Capacitance vs. Applied Voltage

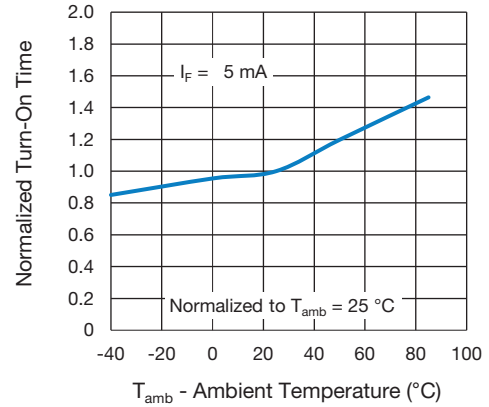


Fig. 13 - Normalized Turn-On Time vs. Ambient Temperature

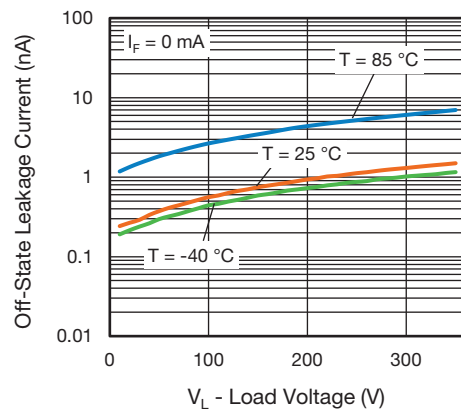


Fig. 11 - Off-State Leakage Current vs. Load Voltage

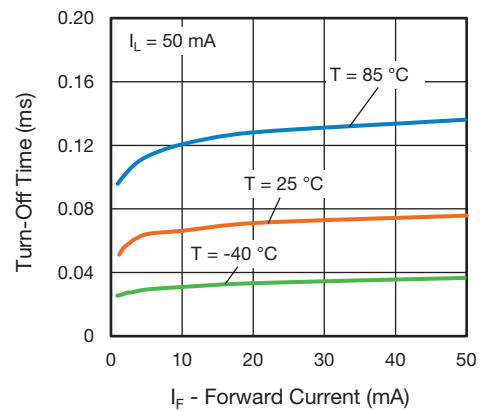


Fig. 14 - Turn-Off Time vs. Forward Current

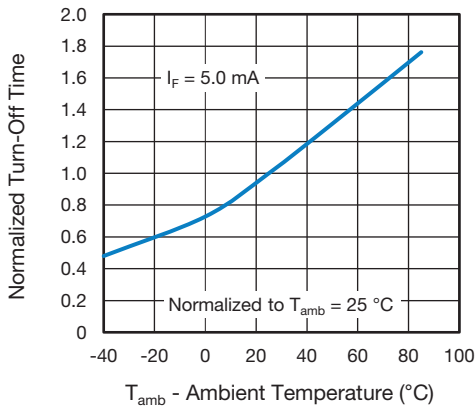
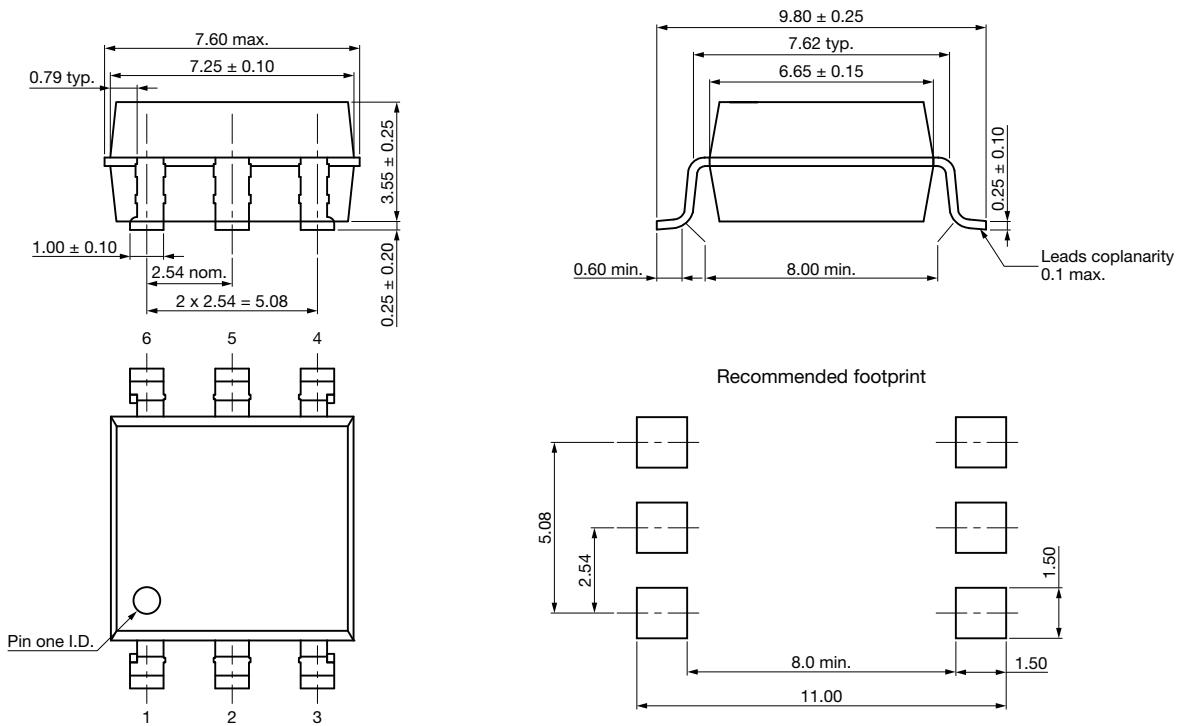


Fig. 15 - Normalized Turn-Off Time vs. Ambient Temperature

**PACKAGE DIMENSIONS** (in millimeters)

**SMD-6**





DIP-6

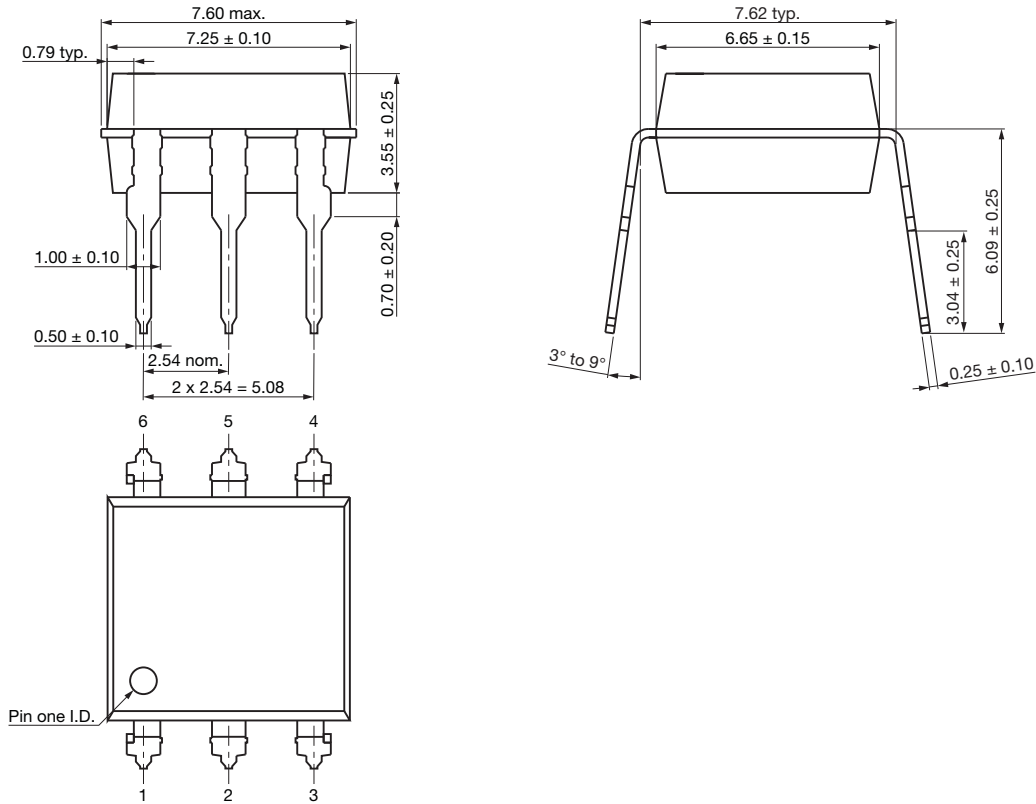


Fig. 16 - Package Drawings

PACKAGE MARKING

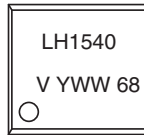
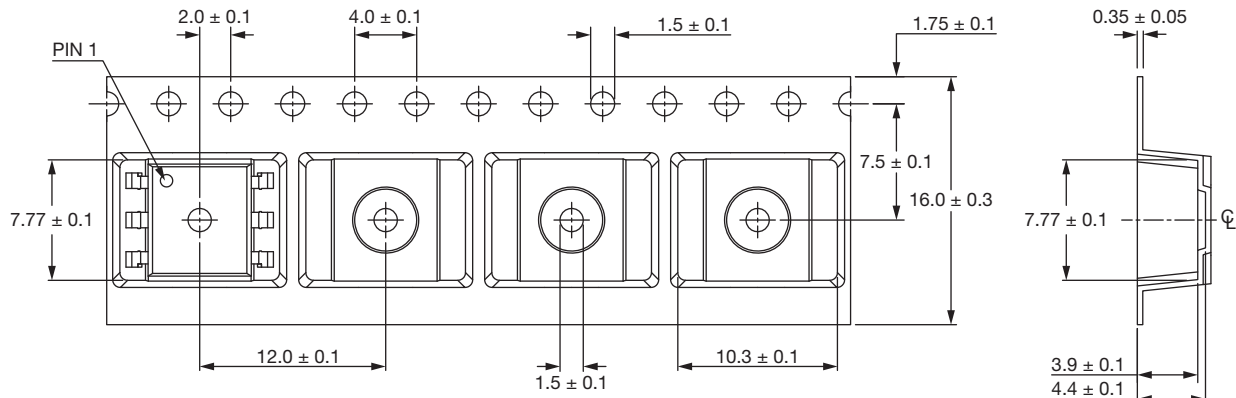


Fig. 17 - LH1540

Note

- Tape and reel suffix (TR) is not part of the package marking

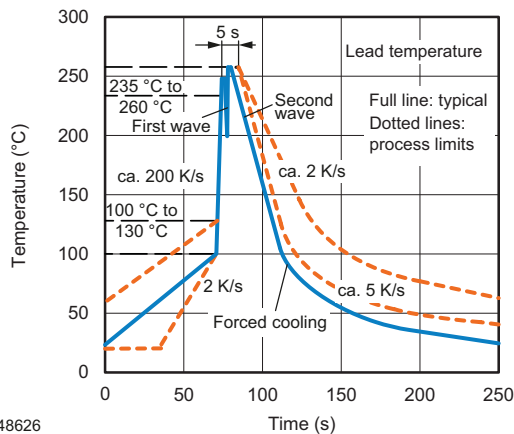
**PACKING INFORMATION** (in millimeters)

**Note:**

- Cumulative tolerance of 10 pocket holes is 0.20 mm

Fig. 18 - Tape and Reel Packing

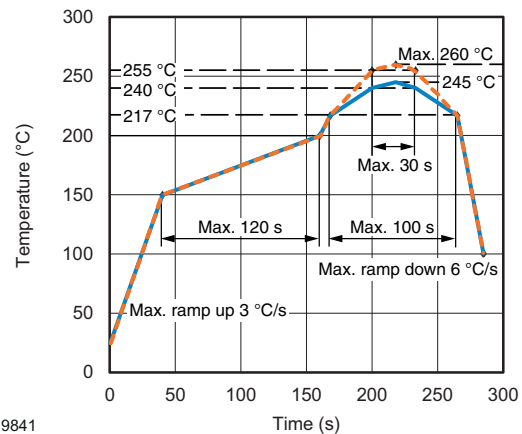
TAPE AND REEL PACKING	
TYPE	UNITS/REEL
SMD-6	1000

TUBE PACKING			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
SMD-6	50	40	2000
DIP-6	50	40	2000

**SOLDER PROFILES**


948626

Fig. 19 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices



19841

Fig. 20 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

**HANDLING AND STORAGE CONDITIONS**

ESD level: HBM class 2

Floor life: unlimited

 Conditions:  $T_{amb} < 30\text{ }^{\circ}\text{C}$ , RH < 60 %

Moisture sensitivity level 1, according to J-STD-020





## Footprint and Schematic Information for LH1540

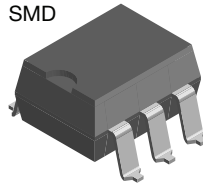
The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

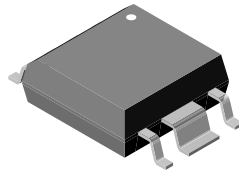
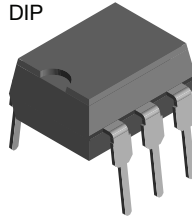
PART NUMBER	FOOTPRINT / SCHEMATIC
LH1540AAB	<a href="http://www.snapeda.com/parts/LH1540AAB/Vishay/view-part">www.snapeda.com/parts/LH1540AAB/Vishay/view-part</a>
LH1540AABTR	<a href="http://www.snapeda.com/parts/LH1540AABTR/Vishay/view-part">www.snapeda.com/parts/LH1540AABTR/Vishay/view-part</a>
LH1540ACD	<a href="http://www.snapeda.com/parts/LH1540ACD/Vishay/view-part">www.snapeda.com/parts/LH1540ACD/Vishay/view-part</a>
LH1540ACDTR	<a href="http://www.snapeda.com/parts/LH1540ACDTR/Vishay/view-part">www.snapeda.com/parts/LH1540ACDTR/Vishay/view-part</a>
LH1540AT	<a href="http://www.snapeda.com/parts/LH1540AT/Vishay/view-part">www.snapeda.com/parts/LH1540AT/Vishay/view-part</a>

For technical issues and product support, please contact [optocoupleranswers@vishay.com](mailto:optocoupleranswers@vishay.com).

SMD



DIP





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